

**FLAME RETARDANT MOLDING COMPOSITIONS
CONTAINING GROUP IVA METAL OXIDES**

ABSTRACT OF THE DISCLOSURE

[0046] A molding composition that is particularly useful for coating and encapsulating electronic or electrical devices is disclosed. The molding composition exhibits improved flame retardancy and includes an epoxy resin, a hardener for the epoxy resin, and flame retardant compounds of melamine cyanurate and an oxyanion of a Group VIA element, such as tungsten trioxide.